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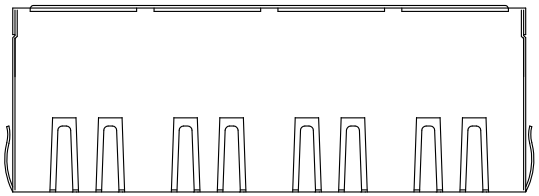
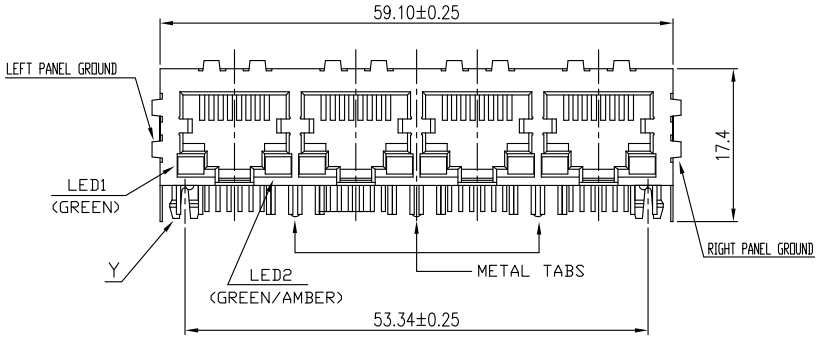
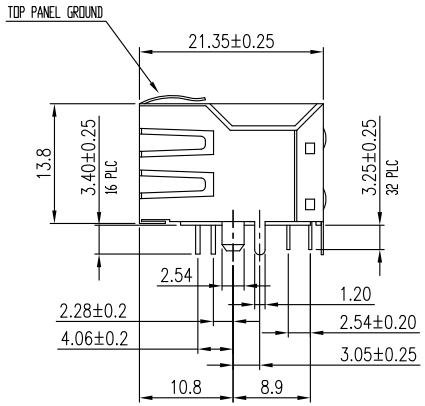
The marking on thisproduct doesn't contain environmental hazardous materials per Material Specification SS-00259 for Sony GP compliant or per directive 2002/95/EC for RoHS compliant.

PRELIMINARY RELEASE
SUBJECT TO CHANGE

REVISIONS				
SYM	ECN No.	DESCRIPTION	DATE	APPROVED
AX1		NON-RELEASE REVISION	10/16/2009	Arron Lin

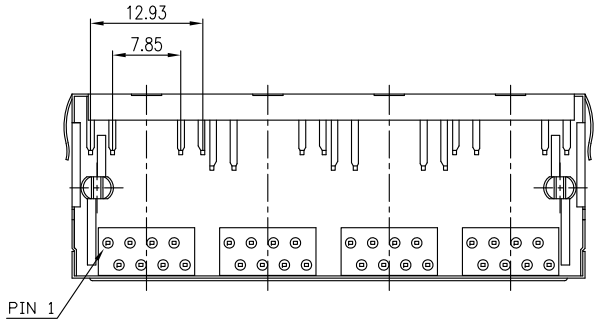


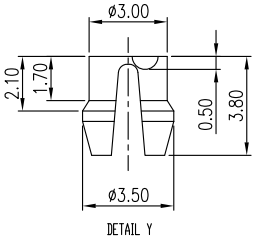


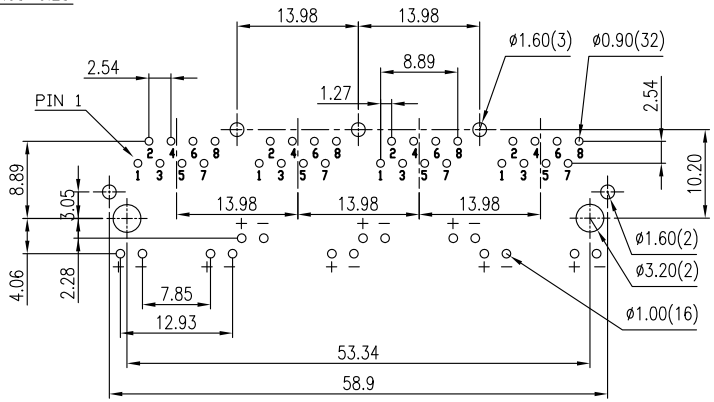


NOTES:
1. MATERIAL:
   HOUSING: HIGH TEMPERATURE THERMAL PLASTIC, PBT UL94V-0, COLOR: BLACK.
   TERMINAL: PHOSPHOR BRONZE.
2. FINISH:
   TERMINAL:
   CONTACT AREA: SELECTED GOLD PLATING;
   SOLDERING AREA: WITH HARD GOLD AND GOLD FLASH PLATING.
3. PACKING IS PER AMTA PACKING SPECIFICATION PKS-0001.
4. THIS PRODUCT DOESN'T CONTAIN ENVIRONMENTAL HAZARDOUS PER DIRECTIVE 2002/95/EC FOR RoHS COMPLIANT.

PART NO. G71E0168X2AEU
- CONTACT FINISH
  1: 6 u" GOLD
  2: 15 u" GOLD
  3: 30 u" GOLD
  4: 50 u" GOLD







PCB LAYOUT
Ref.

TOLERANCE	APPROVALS	DATE	TITLE			
X. ±0.30 X.X ±0.20 X.XXX ±0.10 ANGULAR ±1° UNLESS OTHERWISE SPECIFIED	DRAWN Daniel Hsieh	10/16/2009	RJ 8P8C 4X1 R/A DIP			Amphenol® Amphenol Corporation Amphenol Taiwan Corporation
	CHECKED Roger Tsai	10/16/2009				
	APPROVED Arron Lin	10/16/2009		UNIT mm	SIZE A3	PART No. G71E0168X2AEU
	DWG TYPE CUST DWG	PROJECT CODE MJK		SCALE NA	SHEET 1 OF 1	DWG No. G71E0168X2AEU REV. AX1